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OMB No. 0655 (0011) (94) $(6-12-98)$ Tab settings $\Rightarrow \Rightarrow \Rightarrow$	
	47966hed original documents or copy thereof.
 Name of conveying party(ies): Shuichi Takayama Nobuo Higaki Tetsuya Tanaka Taketo Heishi 	2. Name and address of receiving party(ies) Name: Matsushita Electric Industrial
Masato Suzuki Additional name(s) of conveying party(ies) attached? 🗆 Yes 💩 No	Internal Address:
3. Nature of conveyance:	99/09 06/12
🛱 Assignment 🛛 Merger	Street Address: 1006, Oaza Kadoma, 5
Security Agreement Change of Name	Kadoma-shi, Osaka-fu, Japan
Other	City: State: ZIP:
Execution Date: <u>June 3, 1998</u>	Additional name(s) & address(es) attached? - Q Yes 🖄 No
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the execution date of the application is: <u>June 3</u> , 1998	
A. Patent Application No.(s)	B. Patent No.(s)
Additional numbers attached? Yes No	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Joseph W. Price, Esq.	7. Total fee (37 CFR 3.41)\$ 40.00
Internal Address:	D Enclosed
(Authorized to be charged to deposit account
Street Address:PRICE, GESS & UBELL	8. Deposit account number:
2100 S.E. Main St., Ste. 250	16-2462
City: Irvine State: CA ZIP:92714	(Attach duplicate copy of this page if paying by deposit account)
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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Joseph W. Price	6-12-98
Name of Person Signing NAK1-BD38 Total number of pages/including	Signature Date Over sheet, attachments, and document:
Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments A LENT Washington, D.C. 2013 EEL: 9261 FRAME: 0524	

ASSIGNMENT

WHEREAS, we, <u>Shuichi TAKAYAMA, Nobuo HIGAKI,</u> Tetsuya TANAKA, Taketo HEISHI, and Masato SUZUKI

citizens of Japan, have invented certain new and useful improvements in an <u>CONSTANT RECONSTRUCTING PROCESSOR WHICH</u> SUPPORTS REDUCTIONS IN CODE SIZE

for which we have executed application for Letters Patent of the United States, of even date herewith, and

WHEREAS, MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., a corporation of Japan, having a principal place of business at 1006, Oaza Kadoma, Kadoma-shi, Osaka-fu, Japan, is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application,

NOW, THEREFORE, in consideration of the sum of One Hundred Yen (100 ¥) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, <u>Shuichi TAKAYAMA, Nobuo HIGAKI, Tetsuya TANAKA,</u> Taketo HEISHI, and Masato SUZUKI

have sold, assigned, transferred and set over, unto said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, the entire right, title and interest in, to and under said improvements, and said application and all divisions, renewals and continuations thereof, and all Letters Patents of the United States, which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every country of the Union, and all applications for Letters Patents which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patents which may be granted for said improvements in any country or countries foreign to the United States, and any official of any country or countries foreign to the United States, whose duty it is to issue patents, on applications as aforesaid, to issue all Letters Patents for said improvements to said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its

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successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD., its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand this <u>3rd</u> day of June , 199⁸.

Shuichi Fahayama

IN TESTIMONY WHEREOF, I hereunto set my hand this 3rd day of June , 1998.

Nobuo HIGAKI

IN TESTIMONY WHEREOF, I hereunto set my hand this 3rd

day of <u>June</u>, 199.8.

<u>Jétruya Janaka</u> Tetsuya TANAKA

IN TESTIMONY WHEREOF, I hereunto set my hand this 3rd day of <u>June</u>, 199⁸.

Jaketo Neishi Taketo HEISHI

IN TESTIMONY WHEREOF, I hereunto set my hand this 3rd day of <u>June</u>, 1998.

Marito Sugnhi _____

Page 2 of 2

RECORDED: 06/12/1998